



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

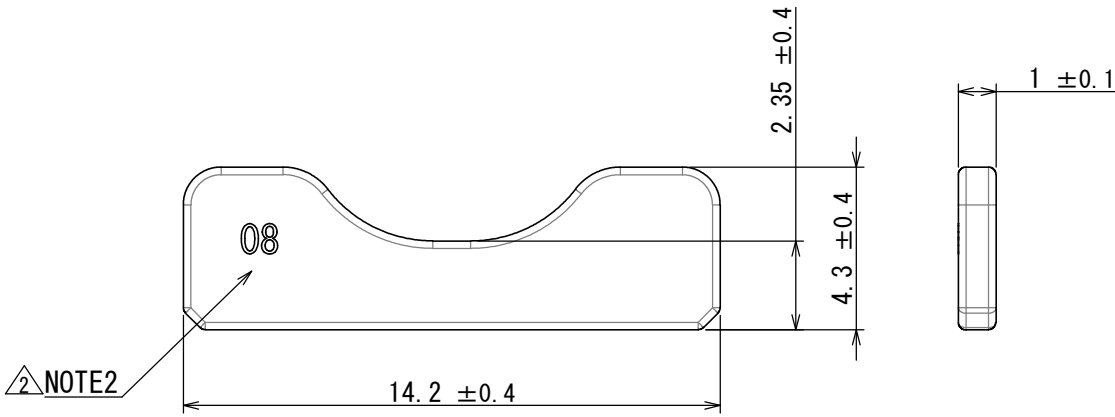
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



| 版数 VER. | 年月日 DATE | CN NO. | 変更内容 DESCRIPTION | 製図 DR. | 担当 CHK. | 査閲 APPD. | 承認 APPD. |
|------------|-------------|--------|-------------------------------------|-----------|------------|-------------|--------------|
| 2 | 20/JAN/2014 | 008598 | CORRECT AN ERROR (REDACTION MARK:1) | | T. SHIINA | O. TAKAGI | T. MIYASHITA |



命名法

DF 02 H CLP 08 B



Applicable hood (A: for 14, 20, 26 contacts,
B: for 36, 50, 68 contacts)
適合フード (A: 14, 20, 26芯用, B: 36, 50, 68芯用)
CLP development No. (01 to 99)
CLP開発No. (0~99)
Part form (CLP: Clamp Plate)
部品形態 (CLP: クランププレート)
Form (H: Hood)
形態 (P: フード用)
Development No.
開発No.

Series
シリーズ

- NOTE 1. SEE JAHL-30303 FOR APPLICABLE HOODS.
NOTE 2. CLP DEVELOPMENT NUMBER IS SHOWN AS INDICATED.
NOTE 3. SEE JAHL-30303 FOR OPERATION OF THE CLAMP PLATE.
NOTE 4. SEE JAHL-30303 FOR APPLICABLE OUTER DIAMETER.
注1. 適用フードについては、JAHL-30303参照。
注2. 図示の位置にCLP開発No. を表示する。
注3. クランププレートの取扱いについてはJAHL-30303参照。
注4. 適用外径はJAHL-30303参照。

| 1 | CLAMP PLATE | 1 | STEEL | NICKEL PLATING | — |
|--------------------------|--------------------|------------------------------------|-----------------|--------------------------------|----------------|
| 符号 NO. | 名 称 DESCRIPTION | 個 数 QTY. | 材 料 MATERIAL | 仕 上 FINISH | 備 考 REMARKS |
| 仕様書 (SPECIFICATION) | | 第1版 (ORIGINAL DATE) 20/NOV/2013 | | 名称 (TITLE) DF02HCLP08B | 日本航空電子工業株式会社 |
| 一般公差 (GENERAL TOLERANCE) | | 製図 DR. | — | | |
| 寸法 (DIMENSION) | | 担当 CHK. | T. SHIINA | | |
| 角度 (ANGLES) | | 査閲 APPD. | O. TAKAGI | | |
| 単位 (UNIT) : mm | | 承認 APPD. | T. MIYASHITA | | |
| シリアル (SERIES) DF02 | | 尺 度 (SCALE) 5:1 | | 図面番号 (DRAWING NO.) SJ114557 | |
| | | | | | 版数 (VER.) 2 |

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S/W

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